

AO4404A

N-Channel Enhancement Mode Field Effect Transistor



General Description

The AO4404A uses advanced trench technology to provide excellent $R_{\rm DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a load switch or in PWM applications. The source leads are separated to allow a Kelvin connection to the source, which may be used to bypass the source inductance. Standard Product AO4404A is Pb-free (meets ROHS & Sony 259 specifications). AO4404AL is a Green Product ordering option. AO4404A and AO4404AL are electrically identical.

Features

 $V_{DS}(V) = 30V$

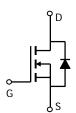
 $I_D = 8.5A (V_{GS} = 10V)$

 $R_{DS(ON)}$ < 24m Ω (V_{GS} = 10V)

 $R_{DS(ON)}$ < 30m Ω (V_{GS} = 4.5V)

 $R_{DS(ON)}$ < 48m Ω (V_{GS} = 2.5V)





Absolute Maximum Ratings T _A =25°C unless otherwise noted								
Parameter		Symbol	Maximum	Units				
Drain-Source Voltage		V_{DS}	30	V				
Gate-Source Voltage		V_{GS}	±12	V				
Continuous Drain	T _A =25°C		8.5					
Current ^A	T _A =70°C	I _D	7.1	A				
Pulsed Drain Current ^B		I _{DM}	60					
	T _A =25°C	Р	2.8	\\\				
Power Dissipation	issipation $T_A = 70^{\circ}C$		1.8	W				
Junction and Storage Temperature Range		T _J , T _{STG}	-55 to 150	°C				

Thermal Characteristics								
Parameter	Symbol	Symbol Typ Max		Units				
Maximum Junction-to-Ambient A	t ≤ 10s	$R_{\theta JA}$	37	45	°C/W			
Maximum Junction-to-Ambient ^A	Steady-State	κ_{θ} JA	70	100	°C/W			
Maximum Junction-to-Lead ^C	Steady-State	$R_{ heta JL}$	26	36	°C/W			

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Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions		Min	Тур	Max	Units
STATIC P	PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$		30			V
I _{DSS}	Zero Gate Voltage Drain Current	V_{DS} =24V, V_{GS} =0V			0.002	1	μА
			T _J =55°C			5	μιτ
I_{GSS}	Gate-Body leakage current	V_{DS} =0V, V_{GS} = ±12V				100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS} I_D=250 \mu A$		0.7	1	1.5	V
$I_{D(ON)}$	On state drain current	V _{GS} =4.5V, V _{DS} =5V		40			Α
R _{DS(ON)}	Static Drain-Source On-Resistance	V_{GS} =10V, I_{D} =8.5A			18	24	mΩ
			T _J =125°C		25	30	11122
		V _{GS} =4.5V, I _D =8.5A			22	30	mΩ
		V_{GS} =2.5V, I_D =5A		32	48	mΩ	
g FS	Forward Transconductance	V _{DS} =5V, I _D =5A		10	26		S
V_{SD}	Diode Forward Voltage	I _S =1A,V _{GS} =0V		0.71	1	V	
I _S	Maximum Body-Diode Continuous Current					4.5	Α
DYNAMIC	PARAMETERS						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =15V, f=1MHz			900	1100	pF
C _{oss}	Output Capacitance				88		pF
C _{rss}	Reverse Transfer Capacitance				65		рF
R_g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz			0.95	1.5	Ω
SWITCHI	NG PARAMETERS						
$\overline{Q_g}$	Total Gate Charge	V _{GS} =4.5V, V _{DS} =15V, I _D =8.5A			10	12	nC
Q_{gs}	Gate Source Charge				1.8		nC
Q_{gd}	Gate Drain Charge				3.75		nC
t _{D(on)}	Turn-On DelayTime				3.2		ns
t _r	Turn-On Rise Time	V_{GS} =10V, V_{DS} =15V, R_L =1.8 Ω , R_{GEN} =6 Ω			3.5		ns
$t_{D(off)}$	Turn-Off DelayTime				21.5		ns
t _f	Turn-Off Fall Time				2.7		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =5A, dI/dt=100A/μs			16.8	20	ns
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =5A, dI/dt=100A/μs			8	12	nC

A: The value of $R_{\theta JA}$ is measured with the device mounted on $1in^2$ FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The value in any given application depends on the user's specific board design. The current rating is based on the t≤ 10s thermal resistance rating.

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B: Repetitive rating, pulse width limited by junction temperature.

C. The R $_{\theta JA}$ is the sum of the thermal impedence from junction to lead $R_{\theta JL}$ and lead to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using $80\mu s$ pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The SOA curve provides a single pulse rating.

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

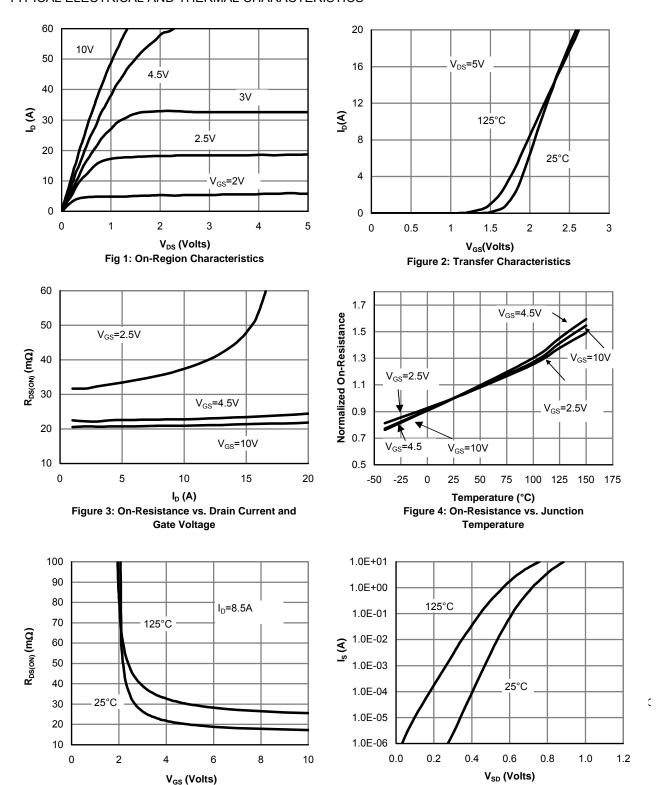


Figure 6: Body-Diode Characteristics

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Figure 5: On-Resistance vs. Gate-Source Voltage

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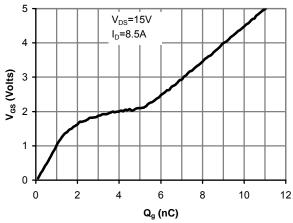


Figure 7: Gate-Charge Characteristics

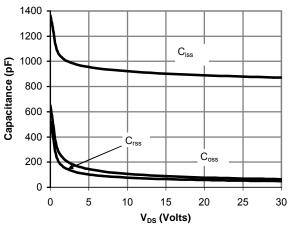


Figure 8: Capacitance Characteristics

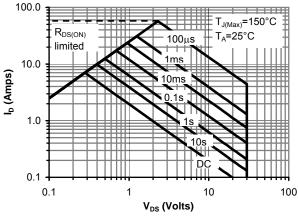


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

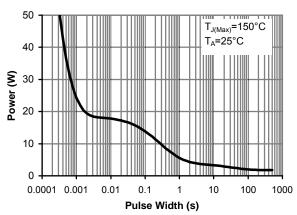


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

C

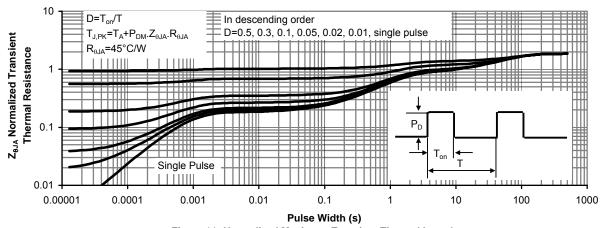


Figure 11: Normalized Maximum Transient Thermal Impedance